

# UNISONIC TECHNOLOGIES CO., LTD

### UTT50P06

Preliminary

**Power MOSFET** 

## -50A, -60V P-CHANNEL (D-S) POWER MOSFET

#### DESCRIPTION

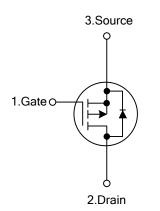
The UTC **UTT50P06** is a P-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed and a minimum on-state resistance, and it can also withstand high energy in the avalanche.

This UTC UTT50P06 is suitable for load switch,etc.

#### FEATURES

- \* V<sub>DS</sub> = -60V
- \* I<sub>D</sub> = -50A
- \* R<sub>DS(ON)</sub>=0.012Ω @ V<sub>GS</sub>=-10V, I<sub>D</sub>=-17A
- \* High Switching Speed

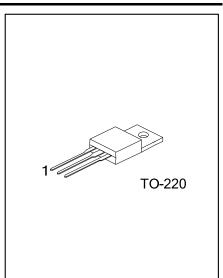
#### SYMBOL



#### ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Deaking
Lead Free	Halogen Free	Package	1	2	3	Packing
UTT50P06L-TA3-T	UTT50P06G-TA3-T	TO-220	G	D	S	Tube
Note: Pin Assignment: G: Gate D: Drain S: Source						
UTT50P06L-TA3-T						

- (1)Packing Type	(1) T: Tube
(2)Package Type	(2) TA3: TO-220
(3)Lead Free	(3) G: Halogen Free, L: Lead Free



#### ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>A</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source V	/oltage		V <sub>DSS</sub>	-60	V
Gate-Source V	oltage		V <sub>GSS</sub>	±20	V
Drain Current		T <sub>C</sub> =25°C	I <sub>D</sub>	-50 (Note 5)	А
	Continuous $(1_j = 175 \text{ C})$	T <sub>C</sub> =125°C		-27.5	А
	Pulsed	I <sub>DM</sub>		-80	А
Avalanche Curi	rent		I <sub>AR</sub>	-50	А
Single Pulse Av	valanche Energy (Note 2)	L=0.1mH	E <sub>AS</sub>	125	mJ
Power Dissipation $\frac{T_{C}=25^{\circ}C}{T_{A}=25^{\circ}C}$		D	113 (Note 4)	14/	
		T <sub>A</sub> =25°C	P <sub>D</sub>	2.5 (Note 3, 4)	W
Junction Tempe	erature		TJ	-55~+150	°C
Storage Tempe	erature		T <sub>STG</sub>	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Duty cycle≤1%.

- 3. When Mounted on 1" square PCB (FR-4 material).
- 4. See SOA curve for voltage derating.
- 5. Package limited.

#### THERMAL CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient (Note 3)	t≤10s	0	18	
	Steady State	$\theta_{JA}$	50	°C/W
Junction to Case		θις	1.1	



#### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250µA	-60			V
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250µA	-1		-3	V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V			-1	
			V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C			-50	μA
			V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C			-100	
Gate- Source Leakage Current	Forward	- I <sub>GSS</sub>	V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			+100	nA
	Reverse		V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-100	nA
ON CHARACTERISTICS	•	•	•				
Static Drain-Source On-State Resistance (Note 1)			V <sub>GS</sub> =-10V, I <sub>D</sub> =-17A		0.012	0.015	Ω
		_	V <sub>GS</sub> =-10V, I <sub>D</sub> =-50A, T <sub>J</sub> =125°C			0.025	
		R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-50A, T <sub>J</sub> =150°C			0.028	
			V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-14A			0.020	
Forward Transconductance (Note 1)		<b>g</b> <sub>FS</sub>	V <sub>DS</sub> =-15V, I <sub>D</sub> =-17A		61		S
On State Drain Current (Note 1)		I <sub>D(ON)</sub>	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-5V	-50			Α
DYNAMIC PARAMETERS (Note	2)						
Input Capacitance		CISS	V <sub>GS</sub> =0V, V <sub>DS</sub> =-25V, f=1MHz		4950		pF
Output Capacitance		Coss			480		рF
Reverse Transfer Capacitance		C <sub>RSS</sub>	-		405		pF
SWITCHING PARAMETERS (No	ote 2, 3)	•			•		
Total Gate Charge		Q <sub>G</sub>			110	165	nC
Gate to Source Charge		Q <sub>GS</sub>	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-30V, I <sub>D</sub> =-50A		19		nC
Gate to Drain Charge		Q <sub>GD</sub>	-		28		nC
Turn-ON Delay Time		t <sub>D(ON)</sub>			15	23	ns
Rise Time		t <sub>R</sub>	V <sub>DD</sub> =-30V, R <sub>L</sub> =0.6Ω, I <sub>D</sub> ≈ -50A,		70	105	ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	V <sub>GEN</sub> =-10V, R <sub>G</sub> =6Ω		175	260	ns
Fall-Time		t <sub>F</sub>	1		175	260	ns
SOURCE- DRAIN DIODE RATIN	IGS AND CH		RISTICS (T <sub>C</sub> =25°C) (Note 2)			•	
Maximum Body-Diode Continuous Current		ls				-50	А
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				-80	Α
Drain-Source Diode Forward Volt		V <sub>SD</sub>	I <sub>F</sub> =-50A, V <sub>GS</sub> =0V		-1.0	-1.6	V
Body Diode Reverse Recovery Time		t <sub>RR</sub>	I <sub>F</sub> =-50A, dI/dt=100A/μs		45	70	ns

Notes: 1. Pulse test; pulse width≤300µs, duty cycle≤2%.

2. Guaranteed by design, not subject to production testing.

3. Independent of operating temperature.

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